

STL11N4LLF5

N-channel 40 V, 9.1 mΩ typ., 15 A STripFET[™]V Power MOSFET in a PowerFLAT[™] 3.3 x 3.3 package

Features

Order code	V _{DS}	R _{DS(on)} max	I _D
STL11N4LLF5	40 V	9.7 mΩ	15 A

- Low gate charge
- Very low on-resistance
- High avalance ruggedeness

Applications

Switching applications

Description

This device is an N-channel Power MOSFET developed using STMicroelectronics' STripFET™V technology. The device has been optimized to achieve very low on-state resistance, contributing to a FOM that is among the best in its class. Datasheet – production data

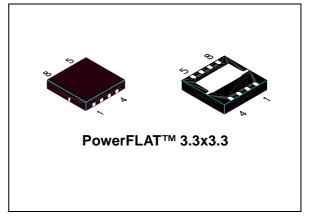


Figure 1. Internal schematic diagram

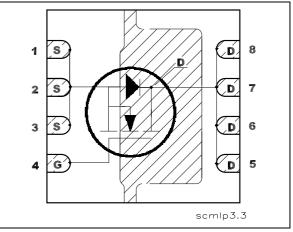


Table 1. Device summary

Order code	Marking	Package	Packaging
STL11N4LLF5	11N4LLF5	PowerFLAT™ 3.3 x 3.3	Tape and reel

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This is information on a product in full production.

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1 Electrical ratings

Symbol	Parameter	Value	Unit
V _{DS}	Drain-source voltage	40	V
V _{GS}	Gate-source voltage	± 20	V
I _D ⁽¹⁾	Drain current (continuous) at T _{pcb} = 25 °C	11	Α
I _D ⁽¹⁾	Drain current (continuous) at T _{pcb} =100 °C	6.8	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	44	Α
P _{TOT} ⁽³⁾	Total dissipation at T _C = 25 °C	50	W
P _{TOT} ⁽¹⁾	Total dissipation at T _{pcb} = 25 °C	2.9	W
	Derating factor ⁽³⁾	0.4	W/°C
T _J T _{stg}	Operating junction temperature storage temperature	-55 to 150	°C

1. The value is rated according Rthj-pcb

2. Pulse width limited by safe operating area.

3. The vaule is rated according Rthj-c

	Table 3.	Thermal resistance
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Symbol	Symbol Parameter		Unit
R _{thj-case}	Thermal resistance junction-case	2.5	°C/W
R _{thj-pcb} ⁽¹⁾	Thermal resistance junction-pcb	42.8	°C/W
R _{thj-pcb} ⁽²⁾	Thermal resistance junction-pcb	63.5	°C/W

1. When mounted on FR-4 board of 1inch² , 2oz Cu, t < 10sec

2. Steady state



2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	$I_{\rm D} = 250 \ \mu {\rm A}, \ {\rm V}_{\rm GS} = 0$	40			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V _{DS} = 40 V, V _{DS} = 40 V, T _C =125 °C			1 10	μΑ μΑ
I _{GSS}	Gate body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			±100	μA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1		2.5	V
R _{DS(on)}	Static drain-source on- resistance	V _{GS} = 10 V, I _D = 5.5 A V _{GS} = 4.5 V, I _D = 5.5 A		9.1 10.6	9.7 12	mΩ mΩ

Table 4. On/off states

Table 5. Dynamic

	Dynamie					
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	V _{DS} =25 V, f=1 MHz, V _{GS} =0		1570 257 32		pF pF pF
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	V _{DD} =15 V, I _D = 11 A V _{GS} =4.5 V (see Figure 14)		12.9 3.9 5.3		nC nC nC
R _G	Gate input resistance	f=1 MHz Gate DC Bias = 0 Test signal level = 20 mV $I_D=0$	0.5	1.5	2.5	Ω

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	V_{DD} =15 V, I _D = 5.5 A, R _G =4.7 Ω , V _{GS} =4.5 V (see Figure 13)	-	14 42 37 5.2	-	ns ns ns ns



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		11	А
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		44	Α
$V_{SD}^{(2)}$	Forward on voltage	I _{SD} =11 A, V _{GS} =0	-		1.1	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I _{SD} =11 A, di/dt = 100 A/μs, V _{DD} =20 V, Tj=150 °C (see Figure 18)	-	27.2 24.5 1.8		ns nC A

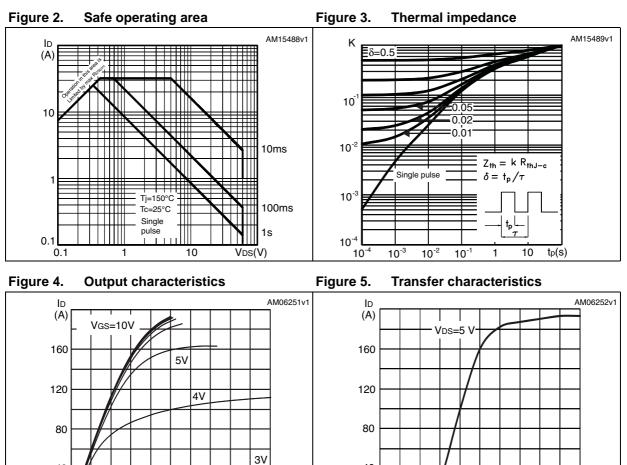
 Table 7.
 Source drain diode

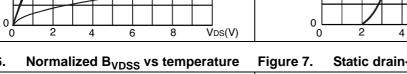
1. Pulse width limited by safe operating area.

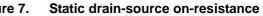
2. Pulsed: pulse duration=300 μ s, duty cycle 1.5%



2.1 Electrical characteristics (curves)



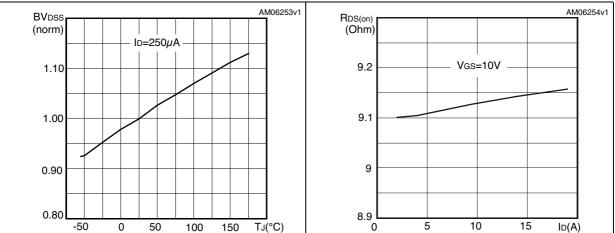




6

8

VGS(V)



40



40

Figure 6.

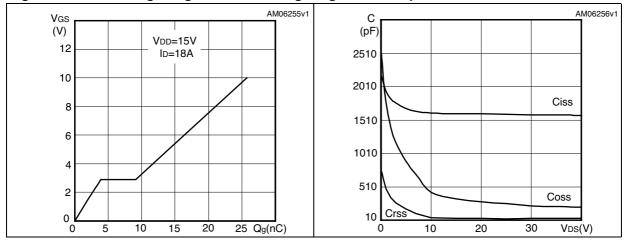


Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

Figure 10. Normalized gate threshold voltage Figure 11. Norm vs temperature temp

Normalized on-resistance vs temperature

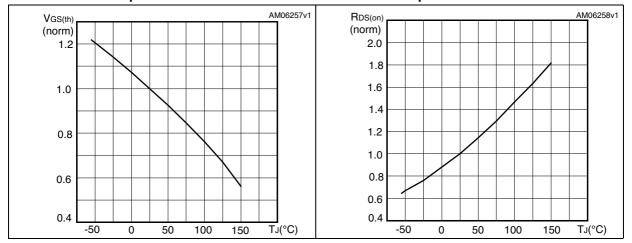
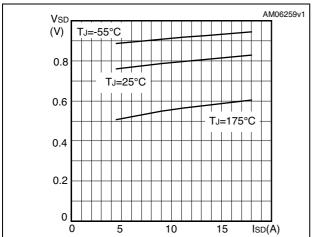


Figure 12. Source-drain diode forward characteristics



57

 $1 k\Omega$

3 Test circuits

Figure 13. Switching times test circuit for resistive load

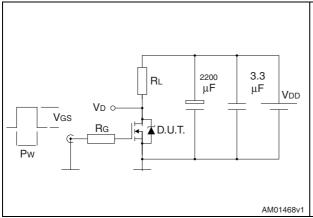
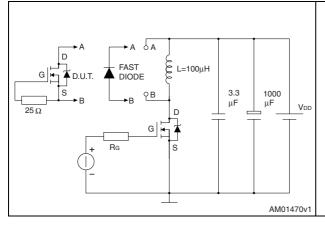


Figure 15. Test circuit for inductive load switching and diode recovery times

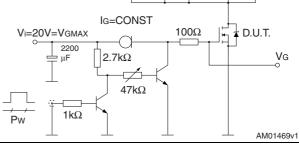




VD

IDM

lр



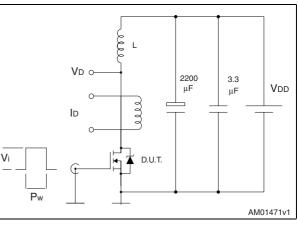
 $47 k\Omega$

<u></u>∔100nF

Figure 14. Gate charge test circuit

12V

Figure 16. Unclamped inductive load test circuit



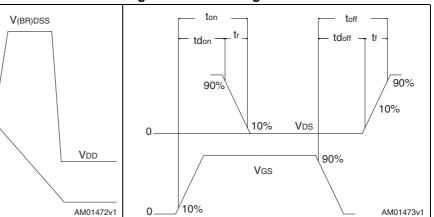


Figure 18. Switching time waveform

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Vdd

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.



Dim.		mm	
Dini.	Min.	Тур.	Max.
А	0.80	0.90	1.00
A1	0		0.05
A3		0.20	
b	0.23		0.38
D	3.20	3.30	3.40
D2	2.50		2.75
E	3.20	3.30	3.40
E2	1.25		1.50
е		0.65	
L	0.30		0.50

Table 8. PowerFLAT[™] 3.3 x 3.3 mechanical data



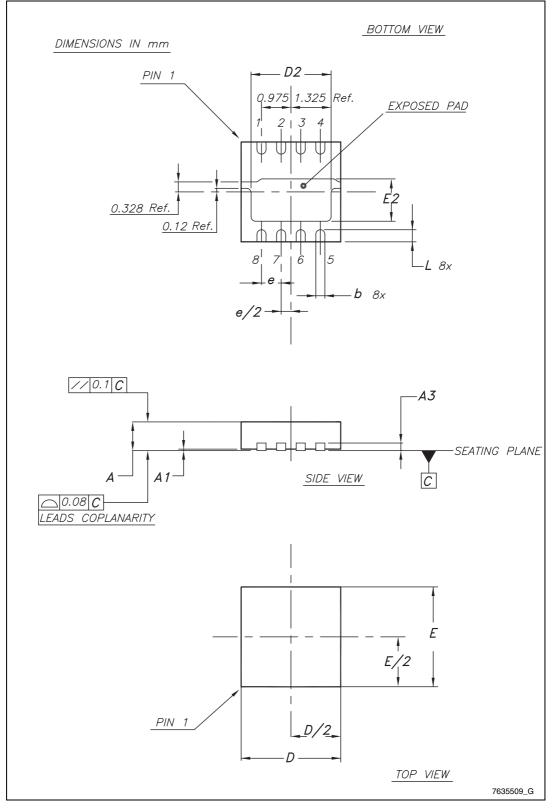


Figure 19. PowerFLAT[™] 3.3 x 3.3 drawing



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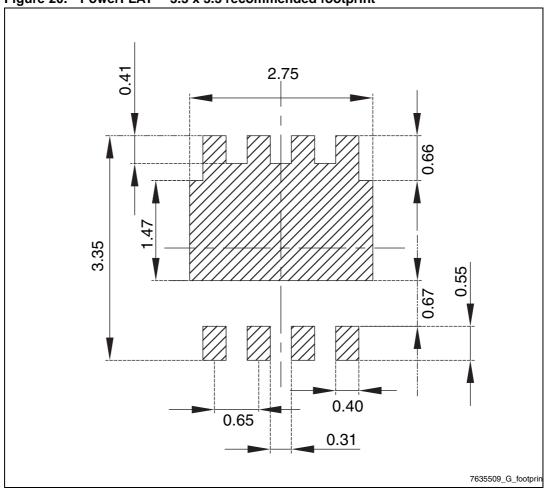


Figure 20. PowerFLAT[™] 3.3 x 3.3 recommended footprint



5 Revision history

Table 9.Document revision history

Date	Revision	Changes
19-Feb-2013	1	First release



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